Hex inverting Schmitt trigger Rev. 7 — 19 November 2015

Product data sheet

General description 1.

The 74HC14; 74HCT14 is a hex inverter with Schmitt-trigger inputs. This device features reduced input threshold levels to allow interfacing to TTL logic levels. Inputs also include clamp diodes, this enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} . Schmitt trigger inputs transform slowly changing input signals into sharply defined jitter-free output signals.

Features and benefits 2.

- Complies with JEDEC standard no. 7A
- Low-power dissipation
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

Applications 3.

- Wave and pulse shapers
- Astable multivibrators
- Monostable multivibrators

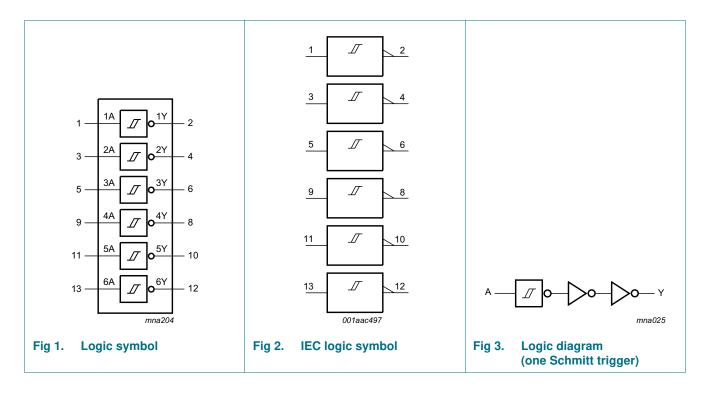


4. Ordering information

Table 1. Ordering information

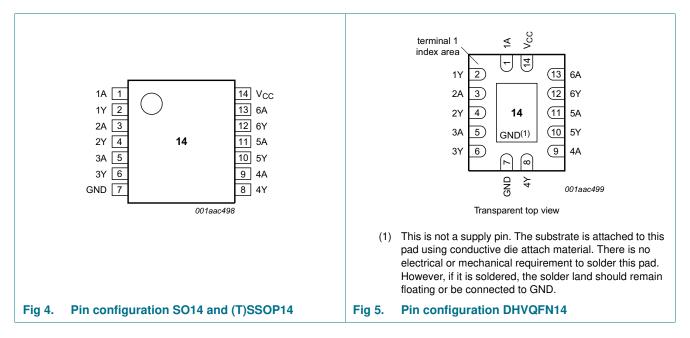
Type number	Package									
	Temperature range Name Description									
74HC14D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1						
74HCT14D	HCT14D 3.9 mm									
74HC14DB	014DB -40 °C to +125 °C SSOP14		plastic shrink small outline package; 14 leads; body	SOT337-1						
74HCT14DB	-		width 5.3 mm							
74HC14PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1						
74HCT14PW	-		body width 4.4 mm							
74HC14BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very	SOT762-1						
74HCT14BQ			thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm							

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 6A	1, 3, 5, 9, 11, 13	data input 1
1Y to 6Y	2, 4, 6, 8, 10, 12	data output 1
GND	7	ground (0 V)
V _{CC}	14	supply voltage

7. Functional description

Table 3. Function table^[1]

Input	Output
nA	nY
L	Н
Н	L

[1] H = HIGH voltage level;

L = LOW voltage level.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
l _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	<u>[1]</u>	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	[1]	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO14, (T)SSOP14 and DHVQFN14 packages	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC14		74HCT14			Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		: –40 °C 85 °C	T _{amb} = −40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC14	1		1	1			1	•		_
V _{OH}	HIGH-level	$V_{I} = V_{T+}$ or V_{T-}								
	output voltage	$I_{O} = -20 \ \mu A; V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{\rm O} = -5.2 \text{ mA}; V_{\rm CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{T+}$ or V_{T-}								
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	2.0	-	20	-	40	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT14	4					1	1	1		
V _{OH}	HIGH-level	$V_{I} = V_{T+}$ or V_{T-} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{T+}$ or V_{T-} ; $V_{CC} = 4.5 V$								
	output voltage	l _O = 20 μA;	-	0	0.1	-	0.1	-	0.1	V
		l _O = 4.0 mA;	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	2.0	-	20	-	40	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other pins at V_{CC} or GND; $I_O = 0 \text{ A}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	30	108	-	135	-	147	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

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11. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see <u>Figure 7</u>.

Symbol	Parameter	Conditions		Ta	_{imb} = 25	°C		-40 °C to 5 °C	Unit
		-		Min	Тур	Max	Max (85 °C)	Max (125 °C)	
74HC14	1								
t _{pd}	propagation delay	nA to nY; see Figure 6	<u>[1]</u>						
		V _{CC} = 2.0 V		-	41	125	155	190	ns
		V _{CC} = 4.5 V		-	15	25	31	38	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	12	-	-	-	ns
		V _{CC} = 6.0 V		-	12	21	26	32	ns
tt	transition time	see <u>Figure 6</u>	<u>[2]</u>						
		V _{CC} = 2.0 V		-	19	75	95	110	ns
		V _{CC} = 4.5 V		-	7	15	19	22	ns
		V _{CC} = 6.0 V		-	6	13	15	19	ns
C _{PD}	power dissipation capacitance	per package; $V_I = GND$ to V_{CC}	<u>[3]</u>	-	7	-	-	-	pF
74HCT14	4		1					1	-
t _{pd}	propagation delay	nA to nY; see Figure 6	[1]						
		V _{CC} = 4.5 V		-	20	34	43	51	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	17	-	-	-	ns
t _t	transition time	$V_{CC} = 4.5 \text{ V}; \text{ see } \frac{\text{Figure 6}}{1000}$	[2]	-	7	15	19	22	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} – 1.5 V	<u>[3]</u>	-	8	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

 $[3] \quad C_{PD} \text{ is used to determine the dynamic power dissipation (P_D in <math>\mu$ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Hex inverting Schmitt trigger

12. Waveforms

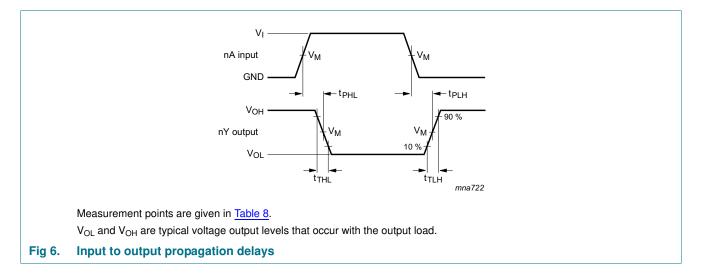
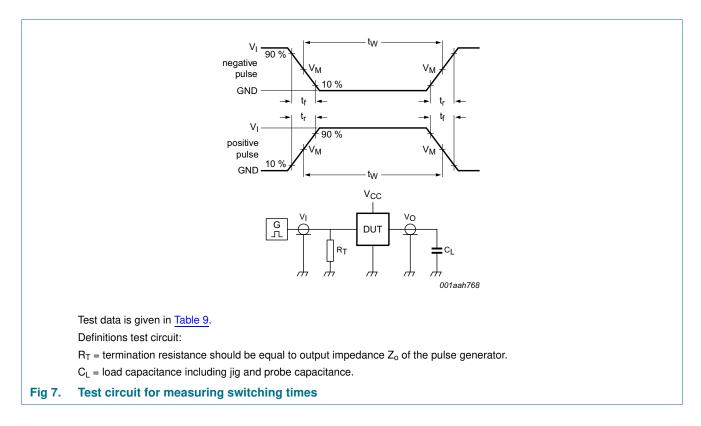


Table 8.Measurement points

Туре	Input	Output				
	V _M	V _M	V _X	V _Y		
74HC14	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}		
74HCT14	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}		



Tab	le 9.	Test data

Туре	Input Lo		Load	Test
	VI	t _r , t _f	CL	
74HC14	V _{CC}	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT14	3.0 V	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

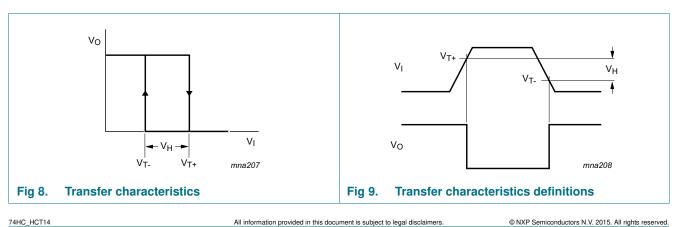
13. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see <u>Figure 8</u> and <u>Figure 9</u>.

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		: –40 °C 85 °C		I25 °C Max 1.5 V 3.15 V 4.2 V 0.9 V 2.0 V 2.6 V 1.4 V 1.4 V	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC14		I	I	1			1	1		
V_{T+}	positive-going	V _{CC} = 2.0 V	0.7	1.18	1.5	0.7	1.5	0.7	1.5	V
	threshold	V _{CC} = 4.5 V	1.7	2.38	3.15	1.7	3.15	1.7	3.15	V
	voltage	V _{CC} = 6.0 V	2.1	3.14	4.2	2.1	4.2	2.1	4.2	V
V_{T-}	negative-going	V _{CC} = 2.0 V	0.3	0.52	0.9	0.3	0.9	0.3	0.9	V
	threshold	V _{CC} = 4.5 V	0.9	1.4	2.0	0.9	2.0	0.9	2.0	V
voltage	vollage	V _{CC} = 6.0 V	1.2	1.89	2.6	1.2	2.6	1.2	2.6	V
V _H	hysteresis	V _{CC} = 2.0 V	0.2	0.66	1.0	0.2	1.0	0.2	1.0	V
	voltage	V _{CC} = 4.5 V	0.4	0.98	1.4	0.4	1.4	0.4	1.4	V
		V _{CC} = 6.0 V	0.6	1.25	1.6	0.6	1.6	0.6	1.6	V
74HCT1	4	.1				L			1	
V_{T+}	positive-going	$V_{CC} = 4.5 V$	1.2	1.41	1.9	1.2	1.9	1.2	1.9	V
	threshold voltage	V _{CC} = 5.5 V	1.4	1.59	2.1	1.4	2.1	1.4	2.1	V
V_{T-}	negative-going	V _{CC} = 4.5 V	0.5	0.85	1.2	0.5	1.2	0.5	1.2	V
threshold voltage		V _{CC} = 5.5 V	0.6	0.99	1.4	0.6	1.4	0.6	1.4	V
V _H	hysteresis	V _{CC} = 4.5 V	0.4	0.56	-	0.4	-	0.4	-	V
	voltage	V _{CC} = 5.5 V	0.4	0.6	-	0.4	-	0.4	-	V

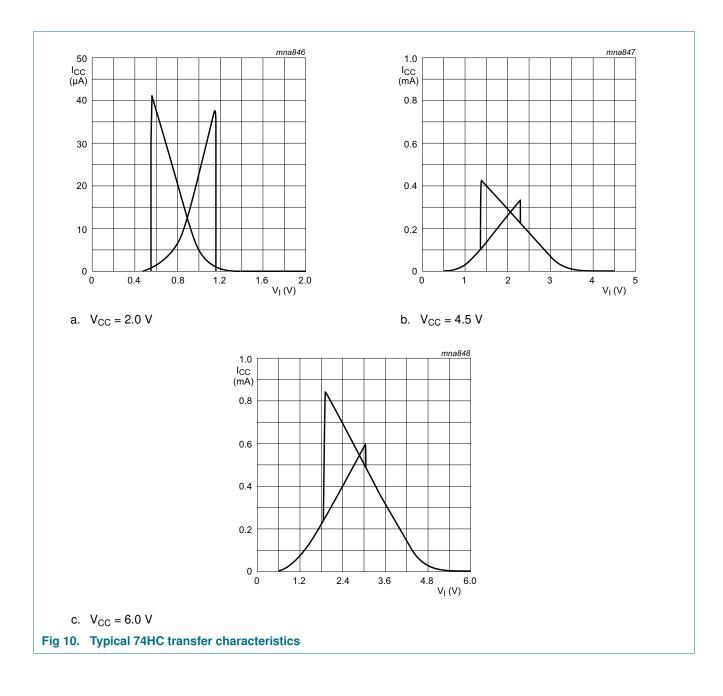
14. Transfer characteristics waveforms



Product data sheet

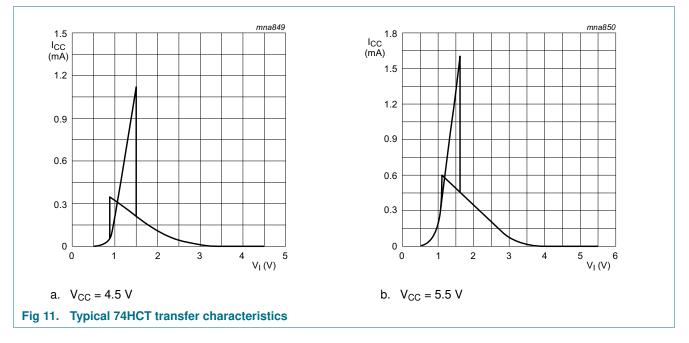
74HC14; 74HCT14

Hex inverting Schmitt trigger



74HC14; 74HCT14

Hex inverting Schmitt trigger



15. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$ where:

 P_{add} = additional power dissipation (μ W);

 $f_i = input frequency (MHz);$

 t_r = rise time (ns); 10 % to 90 %;

 $t_f = fall time (ns); 90 \% to 10 \%;$

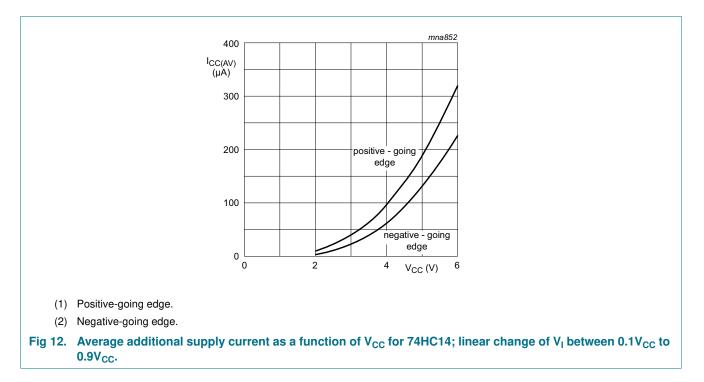
 $\Delta I_{CC(AV)}$ = average additional supply current (µA).

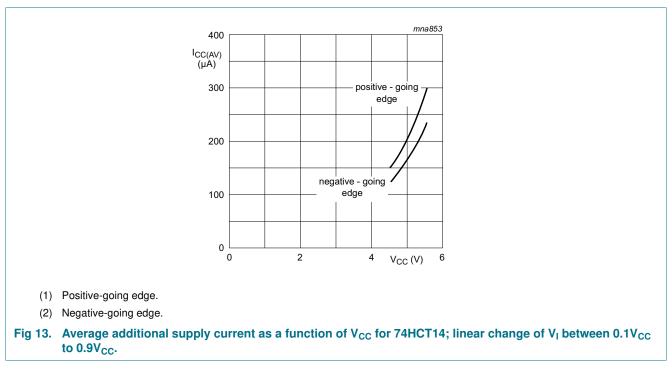
Average $\Delta I_{CC(AV)}$ differs with positive or negative input transitions, as shown in Figure 12 and Figure 13.

An example of a relaxation circuit using the 74HC14; 74HCT14 is shown in Figure 14.

74HC14; 74HCT14

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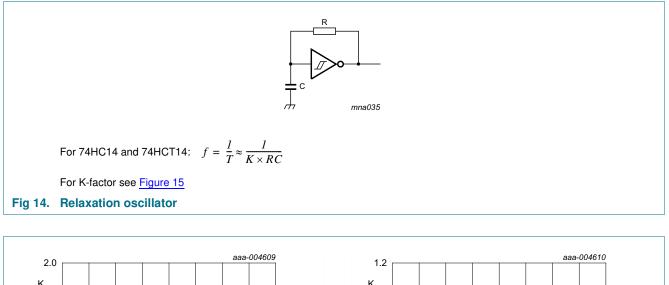


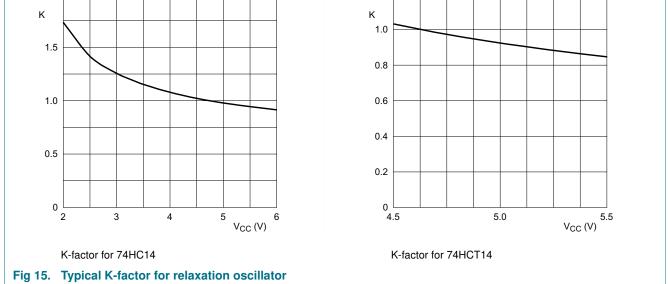


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74HC14; 74HCT14

Hex inverting Schmitt trigger





74HC_HCT14 **Product data sheet**

Hex inverting Schmitt trigger

16. Package outline

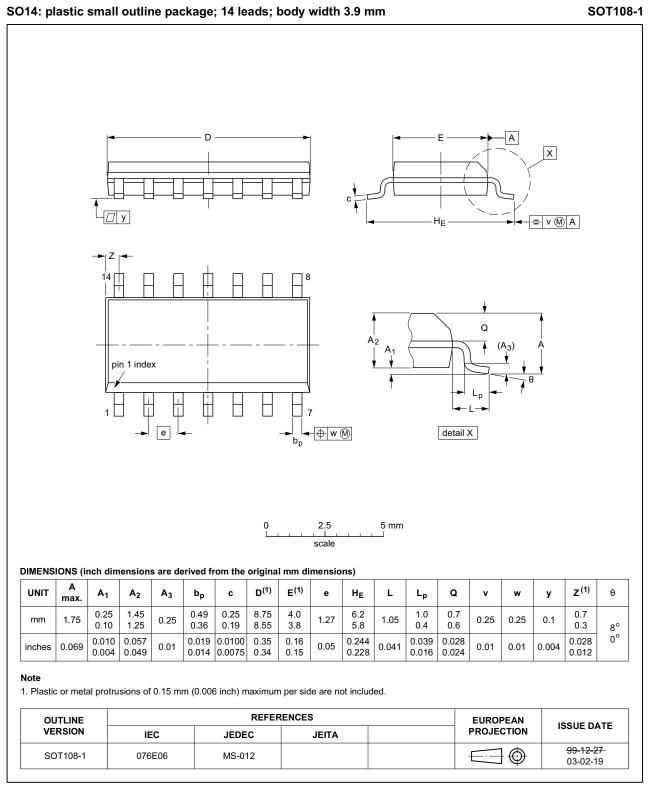


Fig 16. Package outline SOT108-1 (SO14)

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74HC HCT14

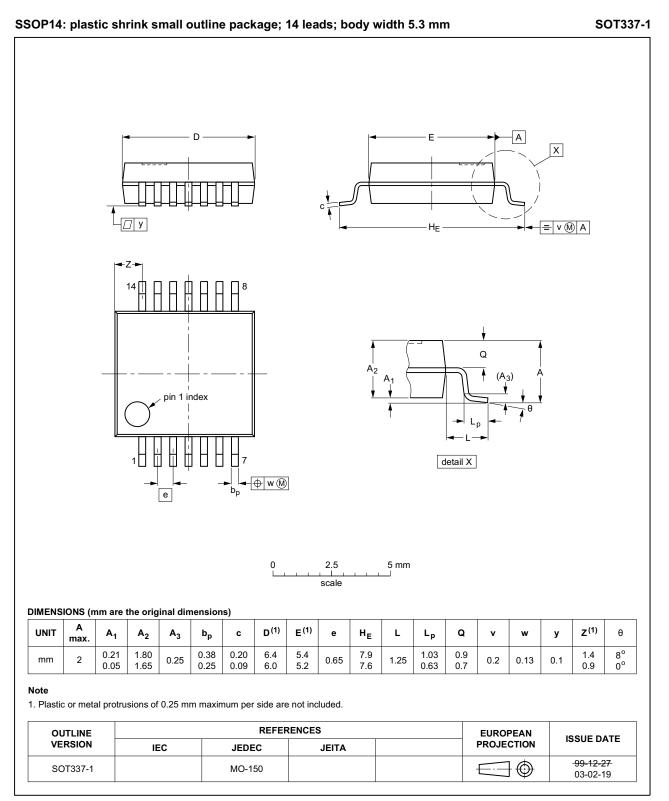


Fig 17. Package outline SOT337-1 (SSOP14)

74HC_HCT14

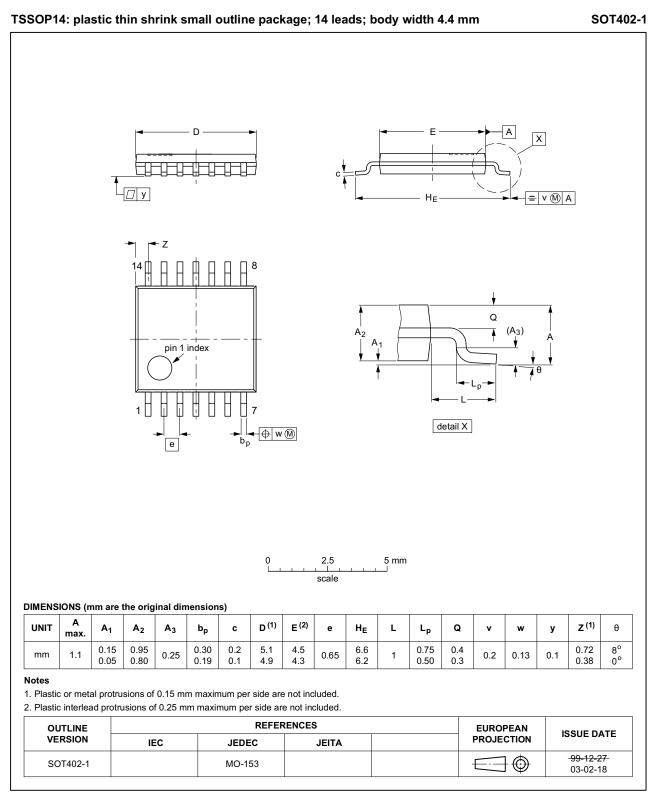
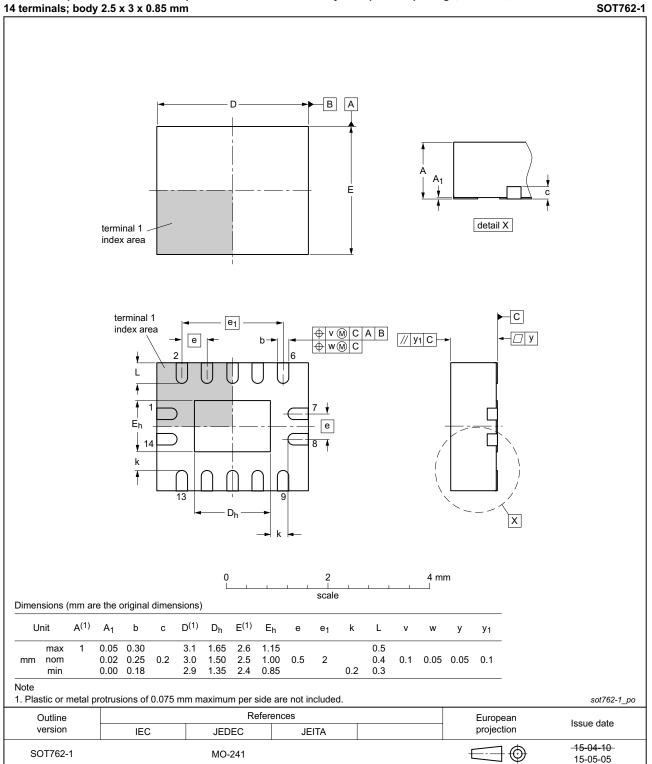


Fig 18. Package outline SOT402-1 (TSSOP14)

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74HC_HCT14

Hex inverting Schmitt trigger



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;

Fig 19. Package outline SOT762-1 (DHVQFN14)

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74HC_HCT14

17. Abbreviations

Table 11. Abbreviations						
Acronym	Description					
CMOS	Complementary Metal-Oxide Semiconductor					
DUT	Device Under Test					
ESD	ElectroStatic Discharge					
НВМ	Human Body Model					
MM	Machine Model					
TTL	Transistor-Transistor Logic					

18. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT14 v.7	20151119	Product data sheet	-	74HC_HCT14 v.6
Modifications:	Type numbers 74HC14N and 74HCT14N (SOT27-1) removed.			
74HC_HCT14 v.6	20120919	Product data sheet	-	74HC_HCT14 v.5
Modifications:	<u>Figure 15</u> added (typical K-factor for relaxation oscillator).			
74HC_HCT14 v.5	20111219	Product data sheet	-	74HC_HCT14 v.4
Modifications:	Legal pages updated.			
74HC_HCT14 v.4	20110117	Product data sheet	-	74HC_HCT14 v.3
74HC_HCT14 v.3	20031030	Product specification	-	74HC_HCT14_CNV v.2
74HC_HCT14_CNV v.2	19970826	Product specification	-	-

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19. Legal information

19.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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74HC HCT14

Hex inverting Schmitt trigger

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Hex inverting Schmitt trigger

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